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Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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308 Constitution Drive Menlo Park, CA 94025-1164 Phone: 800-227-4856 www.circuitprotection.com

SiBar[™] Thyristor Surge Protectors

PRODUCT: TVB300SA-L

DOCUMENT: SCD 25604 PCN: F06500 REV LETTER: C REV DATE: APRIL 28, 2007 PAGE NO.: 1 OF 2

Raychem Circuit Protection Products

Specification Status: Released

PHYSICAL DESCRIPTION







	Α		E	3	C	;	D	**	F	1	ļ	J	k	<
	MIN	MAX												
mm:	4.06	4.57	3.30	3.81	1.90	2.41	1.96	2.11	0.051	0.152	0.15	0.30	0.76	1.27
in*:	(0.160)	(0.180)	(0.130)	(0.150)	(0.075)	(0.095)	(0.077)	(0.083)	(0.002)	(0.006)	(0.006)	(0.012)	(0.030)	(0.050)

	Р	S		
	REF	MIN	MAX	
mm:	0.51	5.21	5.59	
in*:	(0.020)	(0.205)	(0.220)	

*Rounded off approximation

** D DIMENSION SHALL BE MEASURED WITHIN DIMENSION P

Other Physical Characteristics

Form Factor: Lead Material: Encapsulation Material: Solderability: Solder Heat Withstand: Solvent Resistance: Mechanical Shock: Vibration: SMB (Surface Mount, JEDEC DO-214AA Package) Matte Tin finish Epoxy, meets UL94 V-0 requirements per MIL-STD-750, Method 2026 per MIL-STD-750, Method 2031 per MIL-STD-750, Method 1022 per MIL-STD-750, Method 2016 per MIL-STD-750, Method 2056

Tape and Reel packaging per EIA 481-1

Agency Recognition: Precedence: CAUTION:

UL This specification takes precedence over documents referenced herein. Operation beyond the rated voltage or current may result in rupture, electrical arcing or flame.

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REVISIO

Materials Information RoHS Compliant

Directive 2002/95/EC Compliant Directive 2000/53/EC Compliant

ELV Compliant

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Raychem Circuit Protection Products

DEVICE RATINGS @ 25º C (Both Polarities)						
	Parameter	Symbol	Value	Units		
Repetitive Off-State Volt	tage, Maximum at ID = 5 μA	VDM	300	V		
Non-Repetitive Peak	Telcordia GR-1089 CORE 10x1000 μs	IPP ₁	50	A		
Impulse Current	TIA-968 lightning Type A Metallic 10/560 µs	IPP ₂	70	А		
Double exponential	TIA-968 lightning Type A Longit. 10/160 μs	IPP3	100	А		
Waveform	Telcordia GR-1089 Intrabuilding 2/10 µs	IPP4	150	A		
(Notes 1 and 2)	IEC61000-4-5 (Voc 1.2/50us) 8/20 μs	IPP5	150	A		
	ITU-T K.20/K.21 (Voc 10/700us) 5/310 μs	IPP ₆	90	A		
	TIA-968 lightning Type B (Voc 9/720us) 5/320 μs	IPP7	90	A		
Critical Rate of Rise of C	Dn-State Current					
Powered Pulse Amplifie	r, C=30µF, V=600V	di/dt	500	A/μs		
Maximum 2x10 µsec wa	veform, V_{oc} =750V, I_{sc} =150A peak	di/dt	110	A/µs		

DEVICE THERMAL RATINGS

Storage Temperature Range	TSTG	-55 to 150	°C
Operating Temperature Range	ТА	-40 to 125	°C
Blocking or conducting state	14	-40 10 123	0
Overload Junction Temperature	τı	.150	ŝ
Maximum; Conducting state only	13	+150	-0
Maximum Lead Temperature for Soldering Purpose; for 10 seconds	TL	+260	°C

ELECTRICAL CHARACTERISTICS Both polarities (TJ @ 25°C unless otherwise noted)

Cha	Symbol	Min	Тур	Max	Units	
Breakover Voltage (+25°C)		VBO		350	400	V
(dv/dt =0.4kV/μsec, I _{sc} =90	$0mA, V_{DC} = 500V \text{ (both polarites))}$					
Breakover Voltage Tempe	rature Coefficient	dVBO/dTJ		0.1		%/ºC
Off-State Current	(VD1=50V)	ID1			2.0	μA
	(VD2=VDM)	ID2=IDM			5.0	μA
On-State Voltage (IT=1A)		VT			4.0	V
(PW \leq 300 µsec, Duty Cycle \leq 2% (Note 2))		VI			4.0	v
Breakover Current	IBO			800	mA	
Holding Current (Note 2)	IH	150			mA	
Peak Onstage Surge Curre	ITSM	22			^	
(Measured @ 60Hz, 1 cycle, 600V)		11.31vi	22			A
Critical Rate of Rise of Off	dv/dt	2000			V/ue	
(Linear waveform, $V_D = 0.3$	uv/ui	2000			v/µs	
Capacitance	(f=1.0 Mhz, 50V _{DC} bias, 1Vrms)	C1		14		pF
	(f=1.0 Mhz, 2V _{DC} bias, 1Vrms)	C2		27		pF

Note 1. Allow cooling before test second polarity Note 2. Measured under pulse conditions to reduce heating

VOLTAGE-CURRENT CHARACTERISTIC

